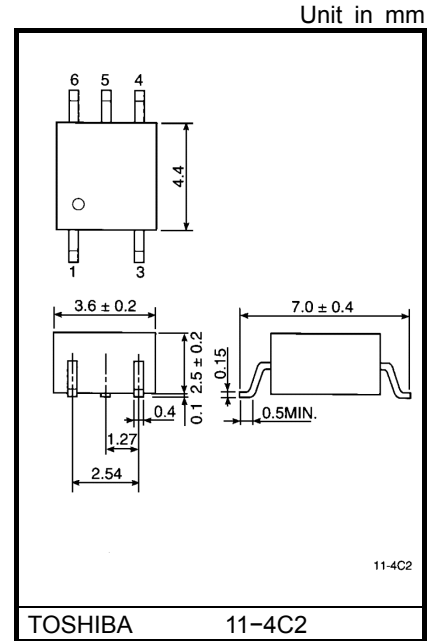


TLP113

- Isolated Line Receiver
- Simplex / Multiplex Data Transmission
- Computer-Peripheral Interface
- Microprocessor System Interface
- Digital Isolation For A / D, D / A Conversion

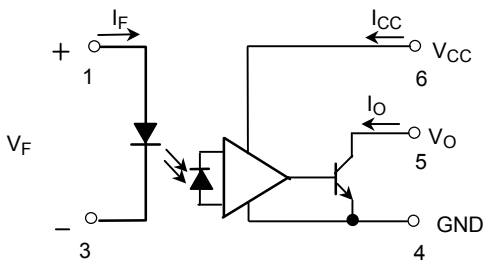
The TOSHIBA mini flat coupler TLP113 is a small outline coupler, suitable for surface mount assembly. TLP113 consists of a GaAlAs light emitting diode, optically coupled to an integrated high gain, high speed photodetector whose output is an open collector, schottky clamped transistor.

- Input current thresholds: $I_F=10\text{mA}(\text{max.})$
- Switching speed: 10MBd(typ.)
- TTL / LSTTL compatible: $V_{CC}=5\text{V}$
- Guaranteed performance over temp.: $0\sim 70^\circ\text{C}$
- Isolation voltage: 2500Vrms(min.)
- UL recognized: UL1577 file no. E67349



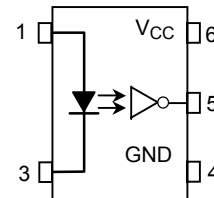
Weight: 0.09g

Schematic



(Note) A 0.1 μF bypass capacitor must be connected between pins 4 and 6.

Pin Configuration(top view)



- 1 : Anode
- 3 : Cathode
- 4 : GND
- 5 : Output
(Open collector)
- 6 : VCC

TRUTH TABLE (Positive Logic)

INPUT	OUTPUT
H	L
L	H

Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit
LED	Forward current	I _F	20	mA
	Pulse forward current (Note 1)	I _{FP}	40	mA
	Peak transient forward current (Note 2)	I _{FPT}	1	A
	Reverse voltage	V _R	5	V
Detector	Output current	I _O	25	mA
	Output voltage	V _O	7	V
	Supply voltage (1 minute maximum)	V _{CC}	7	V
	Output power dissipation	P _O	40	mW
Operating temperature range		T _{opr}	-40~85	°C
Storage temperature range		T _{stg}	-55~125	°C
Lead solder temperature (10s)		T _{sol}	260	°C
Isolation voltage (AC, 1 min., RH ≤ 60%, Note 4)		BV _S	2500	V _{rms}

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

(Note 1) 50% duty cycle, 1ms pulse width.

(Note 2) Pulse width ≤ 1μs, 300pps.

Recommended Operating Conditions

Characteristic	Symbol	Min.	Typ.	Max.	Unit
Input voltage, low level	V _{FL}	-3	0	1.0	V
Input current, high level	I _{FH}	13*	16	20	mA
Supply voltage**	V _{CC}	4.5	5	5.5	V
Fan out (TTL load, each channel)	N	—	—	8	—
Operating temperature	T _{opr}	0	—	70	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

* 13mA is a guard banded value which allows for at least 20% CTR degradation.

Initial input current threshold value is 10mA or less.

**This item denotes operating ranges, not meaning of recommended operating conditions.

Electrical Characteristics(unless otherwise specified, Ta=0~70°C, V_{CC}=4.5~5.5V, V_{FL}≤ 1.0V)

Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Forward voltage	V _F	I _F =10mA, Ta=25°C	—	1.65	1.80	V
Forward voltage temperature coefficient	V _F / Ta	I _F =10mA	—	-2	—	mV / °C
Reverse current	I _R	V _R =5V, Ta=25°C	—	—	10	μA
Capacitance between terminals	C _T	V _F =0, f=1MHz, Ta=25°C	—	45	—	pF
High level output current	I _{OH}	V _F =1.0, V _O =5.5V	—	—	250	μA
		V _F =1.0, V _O =5.5V, Ta=25°C	—	0.5	10	
Low level output voltage	V _{OL}	I _F =10mA I _{OL} =13mA(sinking)	—	0.4	0.6	V
"H level output→ L level output" input current	I _{FH}	I _{OL} =13mA(sinking) V _{OL} =0.6V	—	—	10	mA
High level supply current	I _{CCH}	V _{CC} =5.5V, I _F =0	—	7	15	mA
Low level supply current	I _{CCL}	V _{CC} =5.5V, I _F =16mA	—	12	18	mA
Input-output insulation leakage current	I _S	V _S =3540V, t=5s Ta=25°C (Note 4)	—	—	100	μA
Isolation resistance	R _S	R.H. ≤ 60%, V _S =500V DC Ta=25°C (Note 4)	5×10 ¹⁰	10 ¹⁴	—	Ω
Stray capacitance between input to output	C _S	V _S =0, f=1MHz Ta=25°C (Note 4)	—	0.8	—	pF

* All typical values are V_{CC}=5V, Ta=25°C

Switching Characteristics ($V_{CC}=5V$, $T_a=25^{\circ}C$)

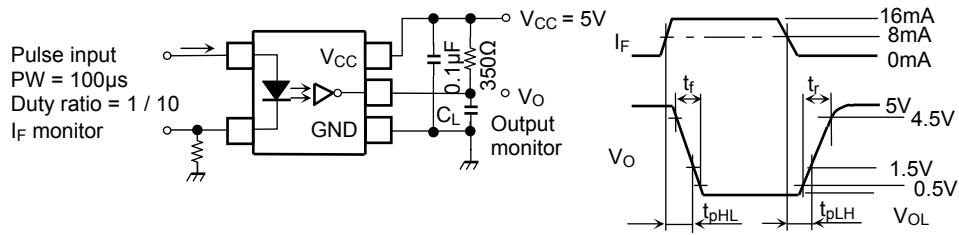
Characteristic	Symbol	Test Circuit	Test Condition	Min.	Typ.	Max.	Unit
Propagation delay time (H→L)	t_{pHL}	1	$I_F=0 \rightarrow 16mA$ $C_L=15pF, R_L=350\Omega$	—	60	120	ns
Propagation delay time (L→H)	t_{pLH}	1	$I_F=16 \rightarrow 0mA$ $C_L=15pF, R_L=350\Omega$	—	60	120	ns
Output rise–fall time (10–90%)	t_r, t_f	2	$R_L=350\Omega, C_L=15pF$ $I_F=0 \rightleftharpoons 16mA$	—	30	—	ns
Common mode transient immunity at high output level	CM_H	2	$I_F=0mA, V_{CM}=200V_{p-p}$ $V_{O(min)}=2V, R_L=350\Omega$	—	200	—	V / μs
Common mode transient immunity at low output level	CM_L	2	$I_F=16mA, V_{CM}=200V_{p-p}$ $V_{O(max)}=0.8V,$ $R_L=350\Omega$	—	-500	—	V / μs

(Note 4) Device considered a two-terminal device: Pins 1 and 3 shorted together, and pins 4, 5 and 6 shorted together.

(Note 5) The V_{CC} supply voltage to each TLP113 isolator must be bypassed by 0.1 μF capacitor, this can be either a ceramic or solid tantalum capacitor with good high frequency characteristic and should be connected as close as possible to package V_{CC} and GND pins of each device.

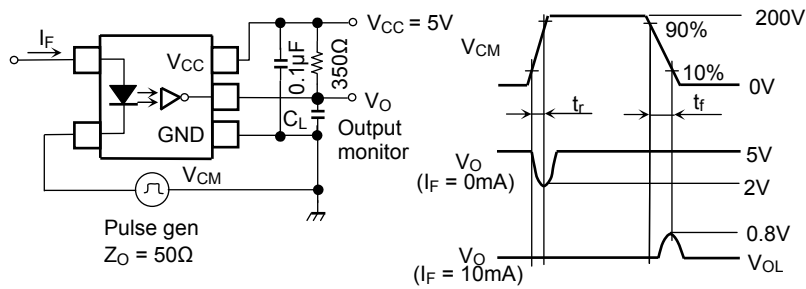
(Note 6) Maximum electrostatic discharge voltage for any pins: 180V(C=200pF, R=0)

Test Circuit 1: Switching Time Test Circuit



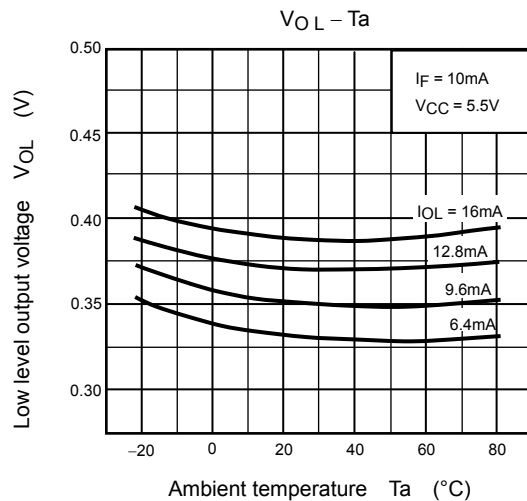
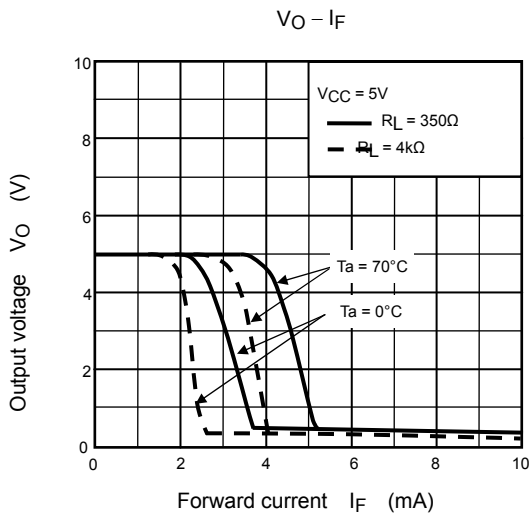
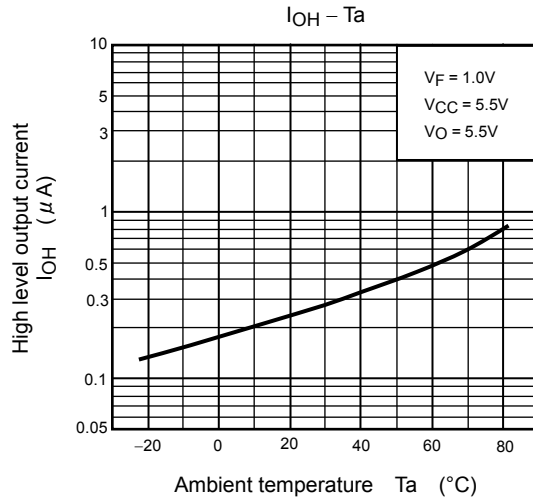
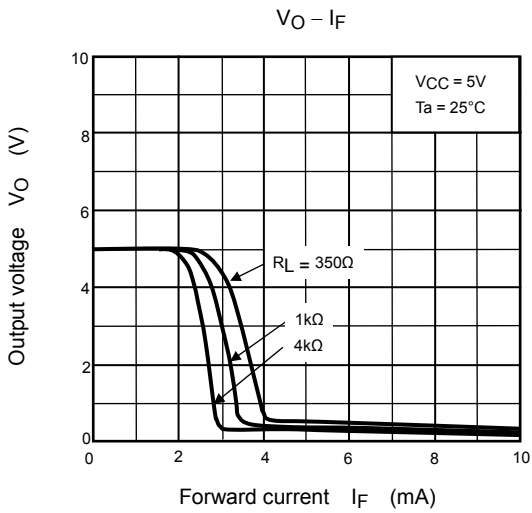
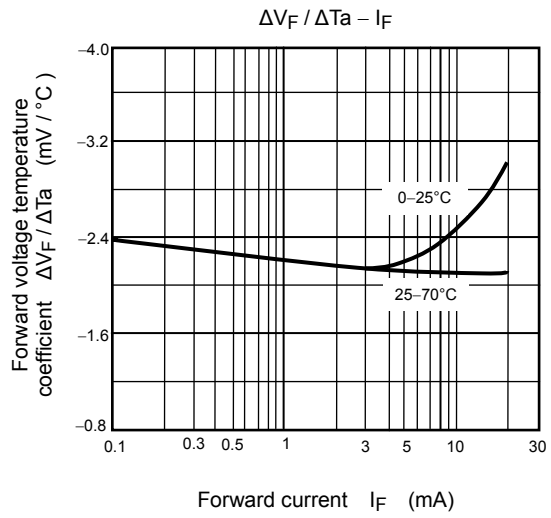
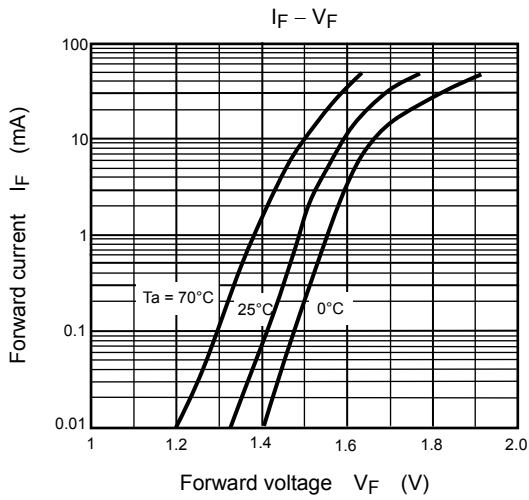
C_L is approximately 15pF which includes probe and stray wiring capacitance.

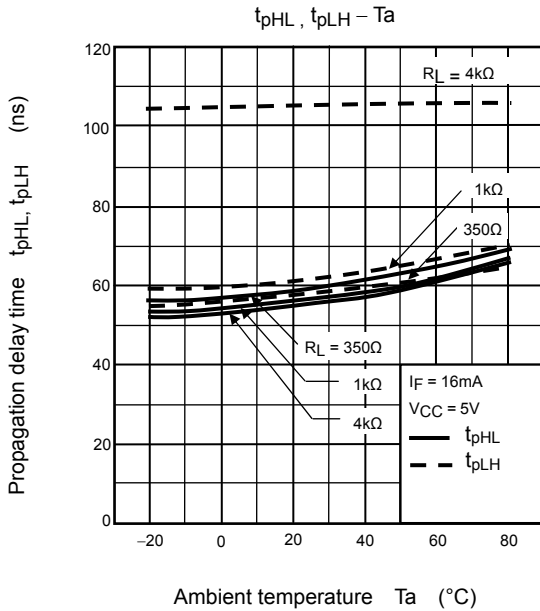
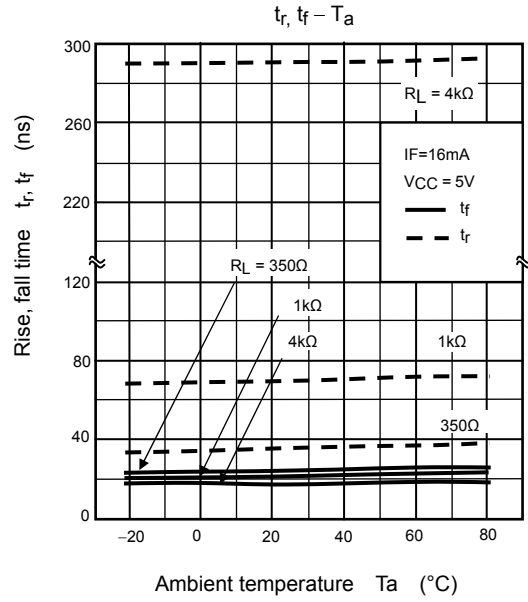
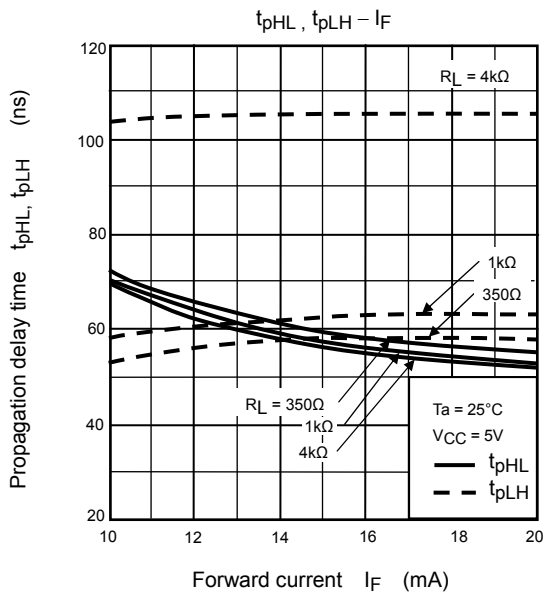
Test Circuit 2: Common Mode Transient Immunity Test Circuit



$$CM_H = \frac{160(V)}{t_r(\mu s)}, CM_L = \frac{160(V)}{t_f(\mu s)}$$

C_L is approximately 15pF which includes probe and stray wiring capacitance.





RESTRICTIONS ON PRODUCT USE

20070701-EN

- The information contained herein is subject to change without notice.
- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property.
In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc.
- The TOSHIBA products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.). These TOSHIBA products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury ("Unintended Usage"). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc.. Unintended Usage of TOSHIBA products listed in this document shall be made at the customer's own risk.
- The products described in this document shall not be used or embedded to any downstream products of which manufacture, use and/or sale are prohibited under any applicable laws and regulations.
- The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by TOSHIBA for any infringements of patents or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any patents or other rights of TOSHIBA or the third parties.
- GaAs(Gallium Arsenide) is used in this product. The dust or vapor is harmful to the human body. Do not break, cut, crush or dissolve chemically.
- Please contact your sales representative for product-by-product details in this document regarding RoHS compatibility. Please use these products in this document in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances. Toshiba assumes no liability for damage or losses occurring as a result of noncompliance with applicable laws and regulations.